

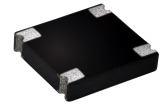
Z4GP206-HF Thru. Z4GP210-HF

Reverse Voltage: 600 to 1000 Volts

Forward Current: 2.0 A

RoHS Device

Halogen free

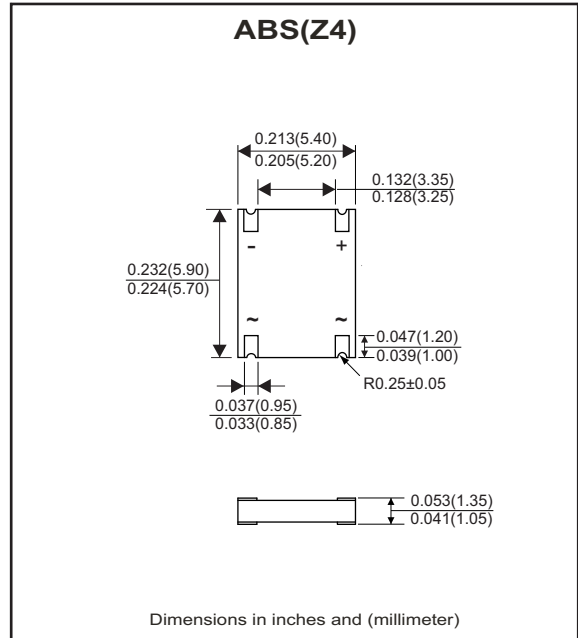


Features

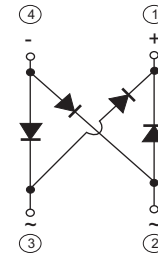
- Internal structure with GPRC (Glass passivated rectifier chip) inside.
- Lead less chip form, no lead damage.
- Low power loss, High efficiency.
- High current capability.
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0 .

Mechanical data

- Case: Packed with FRP substrate and epoxy underfilled.
- Terminals: Pure Tin plated (Lead-Free), solderable per MIL-STD-750, method 2026.
- Polarity: Laser marking symbols
- Weight: 0.11 grams (approx).



Circuit Diagram



Absolute Maximum Rating (at TA=25°C unless otherwise noted)

Parameter	Symbol	Z4GP206-HF	Z4GP208-HF	Z4GP210-HF	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	600	800	1000	V
Average Forward Current	I _(AV)	2.0			A
Peak Forward Surge Current, 8.3ms single half sine-wave, superimposed on rated load (JEDEC Method)	I _{FSM}	50			A
Operating Temperature Range	T _J	-55 to +175			°C
Storage Temperature Range	T _{STG}	-55 to +175			°C

Electrical Characteristics (at TA=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	I _F = 2.0A	-	0.95	1.00	V
Repetitive peak reverse current	I _{RRM}	V _R =Max. V _{RRM} , T _a =25°C	-	0.08	5	uA
Current squared time	I ² t	t<8.3ms, T _a = 25°C	-	10.4	-	A ² S
Junction capacitance	C _J	V _R =4V, f=1.0MHz	-	25	-	pF
Thermal resistance	R _{th(JA)}	Junction to ambient (Note)	-	95	-	°C/W
	R _{th(JL)}	Junction to lead (Note)	-	15	-	°C/W

Notes: Thermal resistance, junction to ambient, measured on PC board with 5.0*5.0mm(0.03mm thick) land areas.

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REV:A

RATING AND CHARACTERISTIC CURVES (Z4GP206-HF Thru. Z4GP210-HF)

Fig.1- Forward Current Derating Curve

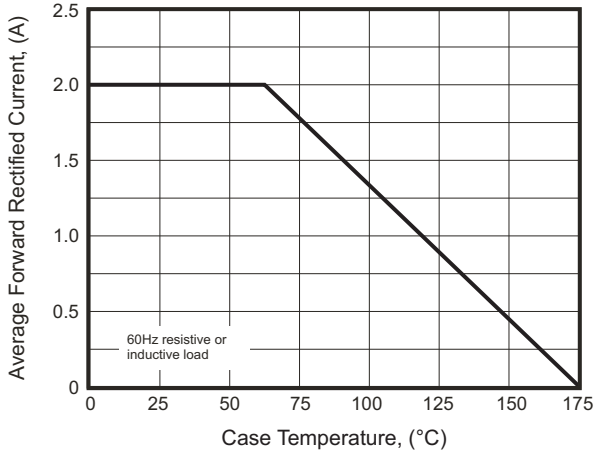


Fig.2- Maximum Non-Repetitive Peak Forward Surge Current

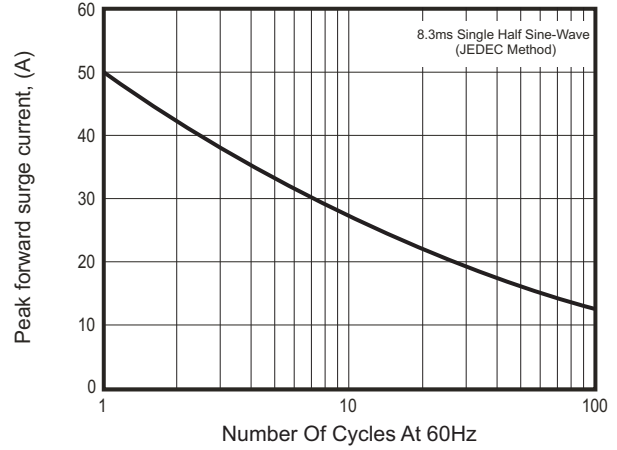


Fig.3- Typical Instantaneous Forward Characteristics

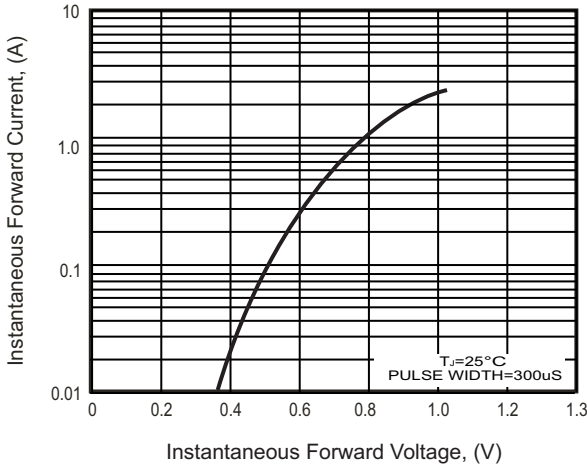


Fig.4- Typical Reverse Characteristics

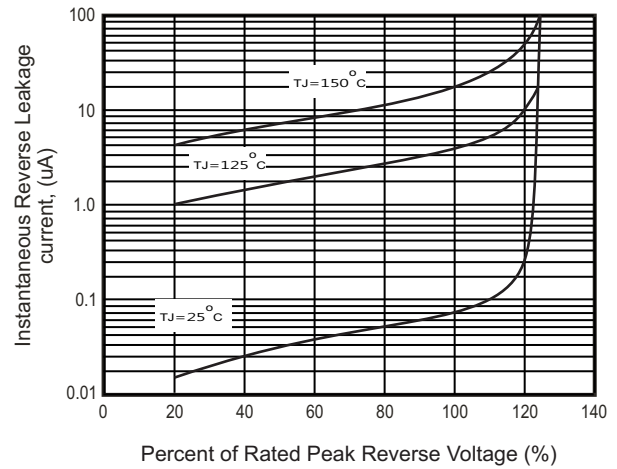
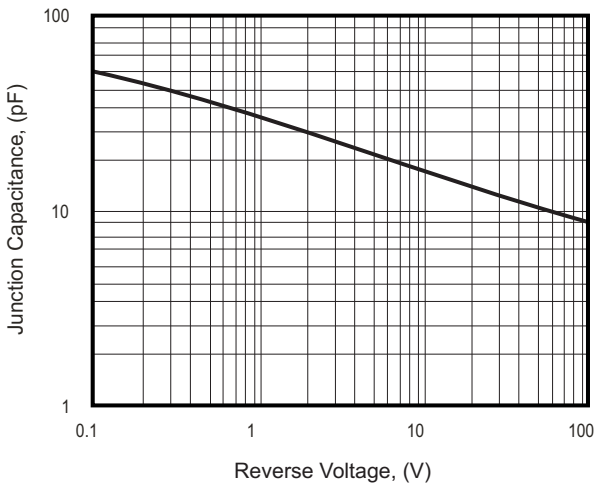
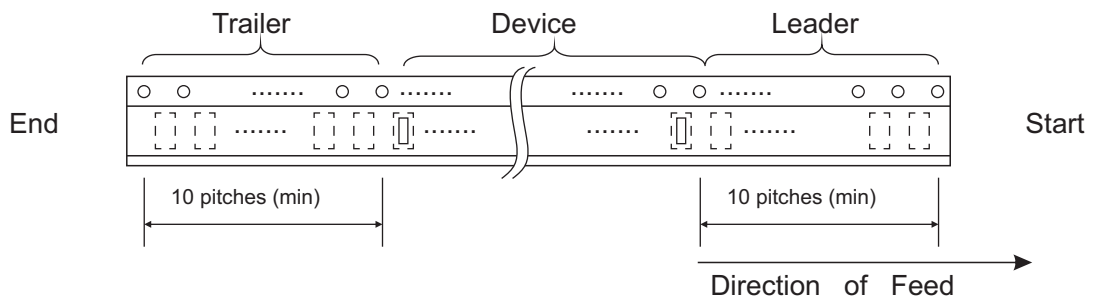


Fig.5 - Typical Junction Capacitance



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Reel Taping Specification



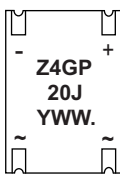
ABS(Z4)	SYMBOL	A	B	C	d	D	D ₁	D ₂
	(mm)	5.65 ± 0.10	6.15 ± 0.10	1.45 ± 0.10	1.50 ± 0.10	330 ± 2.00	50.0 MIN.	13.0 ± 0.50
	(inch)	0.222 ± 0.004	0.242 ± 0.004	0.057 ± 0.004	0.059 ± 0.004	12.992 ± 0.079	1.969 MIN.	0.512 ± 0.020

ABS(Z4)	SYMBOL	E	F	P	P ₀	P ₁	W	W ₁
	(mm)	1.75 ± 0.10	5.50 ± 0.05	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	12.00 ± 0.30	14.4 MAX.
	(inch)	0.069 ± 0.004	0.217 ± 0.002	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.004	0.472 ± 0.012	0.567 MAX.

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Marking Code

Part Number	Marking Code
Z4GP206-HF	Z4GP20J
Z4GP208-HF	Z4GP20K
Z4GP210-HF	Z4GP20M



Z4GP = Series code
 20 = Amps class(2.0A)
 J = Voltage Class
 J = 600V
 K = 800V
 M = 1000V
 . = Halogen-free type

Y = Last digit of the year
 0 = 2010
 1 = 2011
 2 = 2012

WW = Mfg week
 01 = First week
 02 = Second week
 03 = Third week

Suggested PAD Layout



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
ABS(Z4)	5,000	13

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